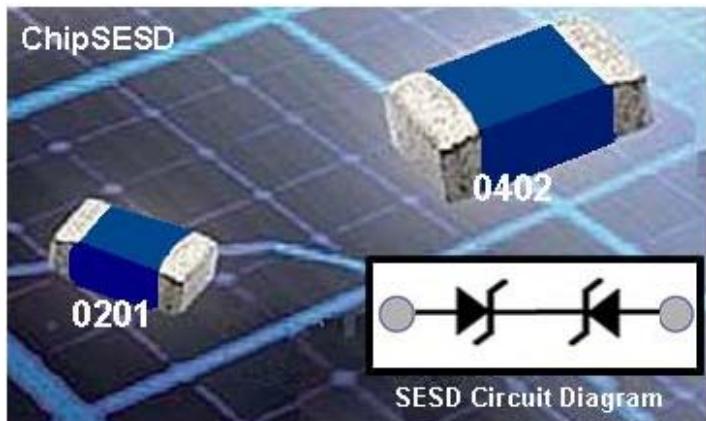


## Specification Status: Released

### BENEFITS

- Silicon ESD device in an EIA-0201 size rectangular passive component SMT package
- Standard PCB assembly and rework processes
- Bi-directional operation allows placement on PCB without orientation constraint
- Appropriate for ESD protection in space-constrained portable electronics and mobile handsets
- Suitable for +5V operating voltage applications
- Helps protect electronic circuits against damage from Electrostatic Discharge (ESD) events
- Assist equipment to pass IEC61000-4-2, level 4 testing
- RoHS compliant and Halogen Free



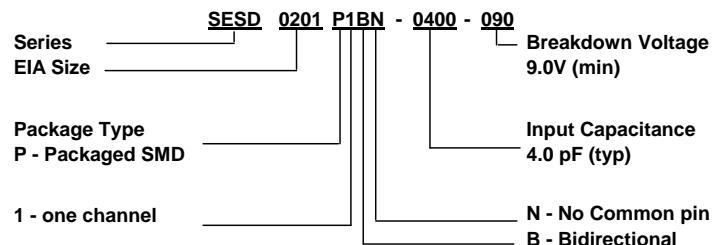
### FEATURES

- Input capacitance – 4pF (typ)
- Low leakage current – 1.0 $\mu$ A (max)
- Low working reverse voltage – 6.0V (max)
- ESD maximum rating per IEC61000-4-2 standard
  - $\pm 10$ kV contact discharge <sup>(1)</sup>
  - $\pm 16$ kV air discharge
- Capable of withstanding numerous ESD strikes
- Small package size: 0.60mm x 0.30mm (typ)
- Low package height: 0.30mm (typ)

### APPLICATIONS

- Cellular phones and portable electronics
- Digital cameras and camcorders
- USB 2.0 and computer I/O ports
- Keypads, pushbuttons, low voltage DC lines, speakers, headphones, microphones
- Applications requiring high ESD performance

### PART NUMBERING



### MATERIALS INFORMATION

RoHS Compliant    ELV Compliant    Halogen Free \*

 Directive 2000/53/EC  
Compliant

 Directive 2002/95/EC  
Compliant

 \* Halogen Free refers to: Br $\leq$ 900ppm, Cl $\leq$ 900ppm, Br+Cl $\leq$ 1500ppm

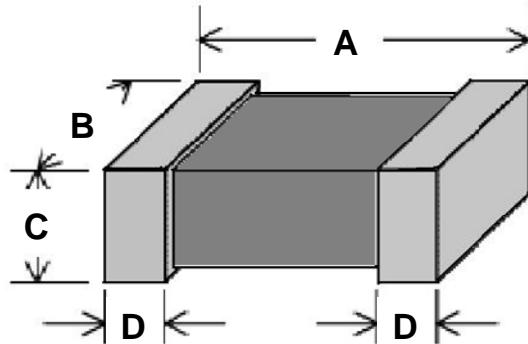
Terminal finish: 100% Matte Tin (Sn)

Device Characteristics @ T = 25°C	Min	Typ	Max	Unit
Input Capacitance @ V <sub>r</sub> = 0V, f = 1MHz	--	4.0	5.0	pF
Working Reverse Voltage (peak) - V <sub>RWM</sub>	--	--	6.0	V
Breakdown Voltage – V <sub>br</sub> @ I <sub>t</sub> = 1mA <sup>(2)</sup>	9.0	11.0	--	V
Leakage current @ V <sub>RWM</sub> = 6.0V	--	--	1.0	$\mu$ A
Clamping Voltage @ I <sub>pp</sub> =2A, t <sub>p</sub> =(8/20 $\mu$ s)	--	$\pm$ 10.0	$\pm$ 12.0	V
ESD contact discharge per IEC61000-4-2 standard <sup>(1)</sup>	--	--	$\pm$ 10	kV
ESD air discharge per IEC61000-4-2 standard	--	--	$\pm$ 16	kV
Operating (T <sub>junction</sub> ) and Storage Temperature Range	-40 to +125			°C

<sup>(1)</sup> 10kV @  $\pm$  50 pulses under IEC61000-4-2; 8kV @ 1,000 pulses under IEC61000-4-2

<sup>(2)</sup> V<sub>br</sub> is measured at test current I<sub>t</sub>

### DEVICE DIMENSIONS

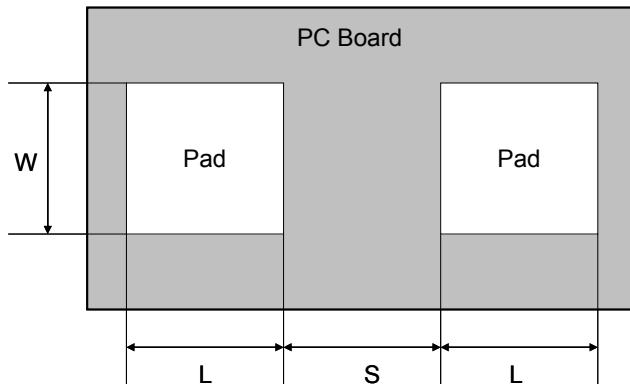


*Drawing Not To Scale*

Typical	A	B	C	D
mm	0.60 ± 0.05	0.30 ± 0.05	0.30 ± 0.05	0.21 ± 0.07
mils*	23.62 ± 2.0	11.81 ± 2.0	11.81 ± 2.0	8.27 ± 2.8

\* Round off approximation

### RECOMMENDED LANDING PATTERN:



	L	S	W
mm	0.28 ± 0.01	0.19 ± 0.01	0.30 ± 0.01
mils*	11.0 ± 0.4	7.5 ± 0.4	11.8 ± 0.4

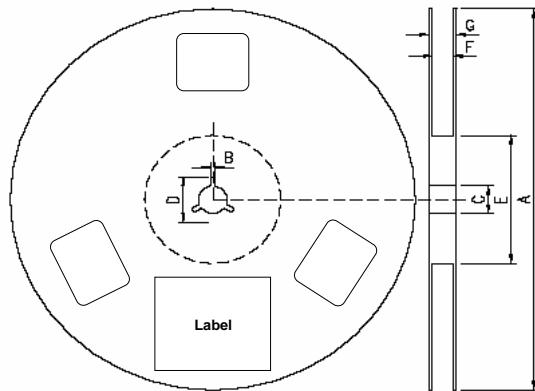
\* Round off approximation

- Recommended solder thickness: 150 to 200  $\mu\text{m}$
- Recommended rework procedure:
  - Soldering iron tip temperature should be less than 350°C
  - Apply iron tip to solder for less than 5 seconds
  - Do not apply solder iron tip to the body of this product directly

## PACKAGING

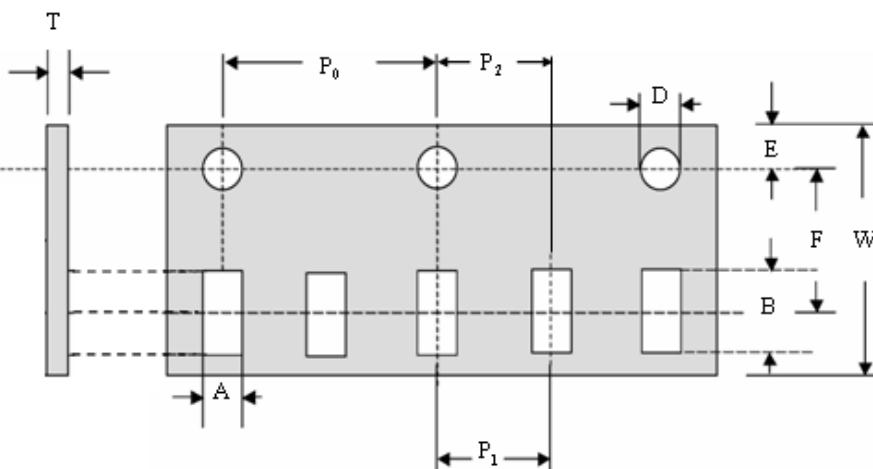
Packaging	Tape & Reel	Standard Box
SESD0201P1BN-0400-090	15,000	75,000

## REEL DIMENSIONS



Dimension	A	B	C	D	E	F	G
(mm)	178.0 ± 2.0	2.0 ± 0.5	13.0 ± 0.5	21.0 ± 0.8	62.0 ± 1.5	9.0 ± 0.5	13.0 ± 1.0

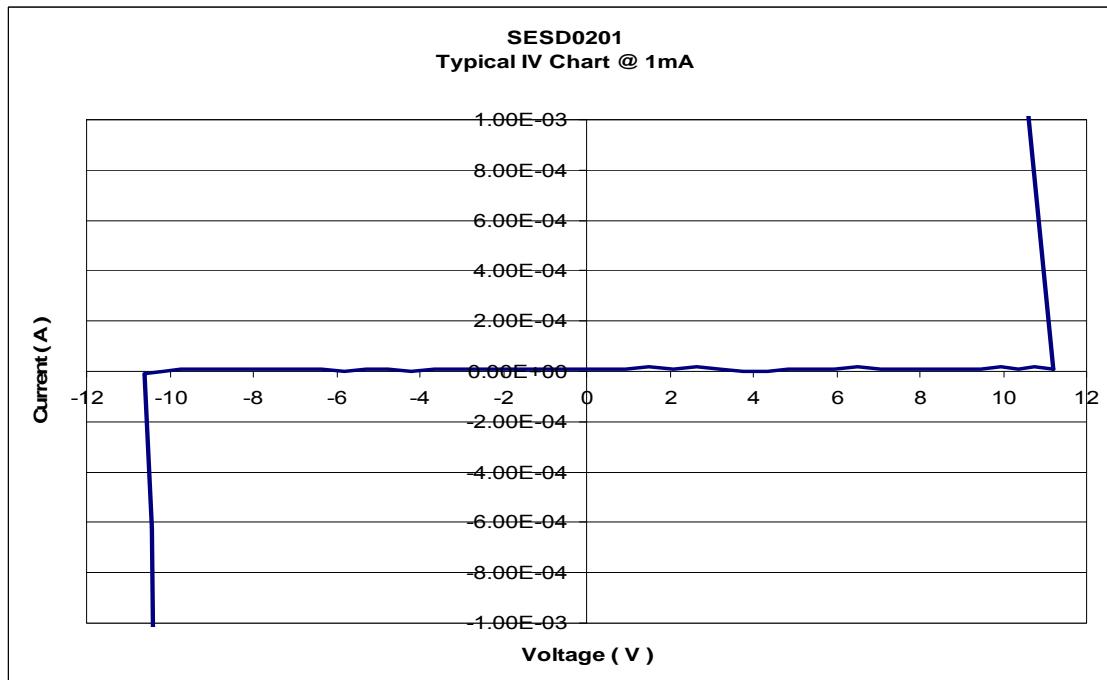
## CARRIER TAPE DIMENSIONS



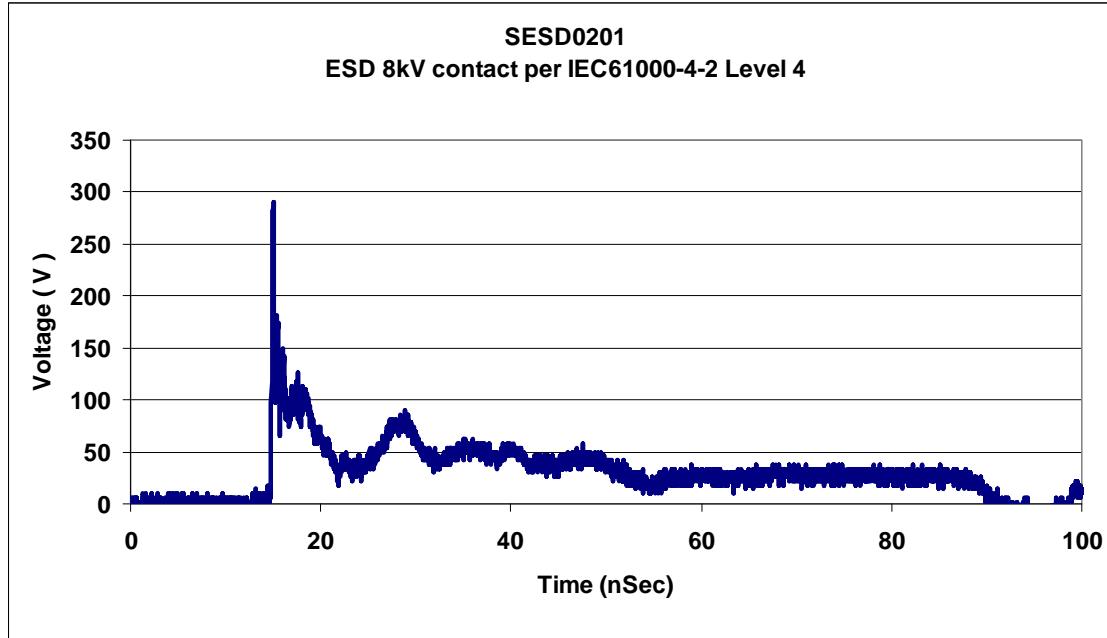
Dimension	A	B	D	E	F	W
(mm)	0.35 ± 0.02	0.67 ± 0.02	1.55 ± 0.05	1.75 ± 0.05	3.5 ± 0.05	8.0 ± 0.1

Dimension	P <sub>0</sub>	P <sub>1</sub>	P <sub>2</sub>	T
(mm)	4.0 ± 0.1	2.0 ± 0.05	2.0 ± 0.05	0.42 ± 0.03

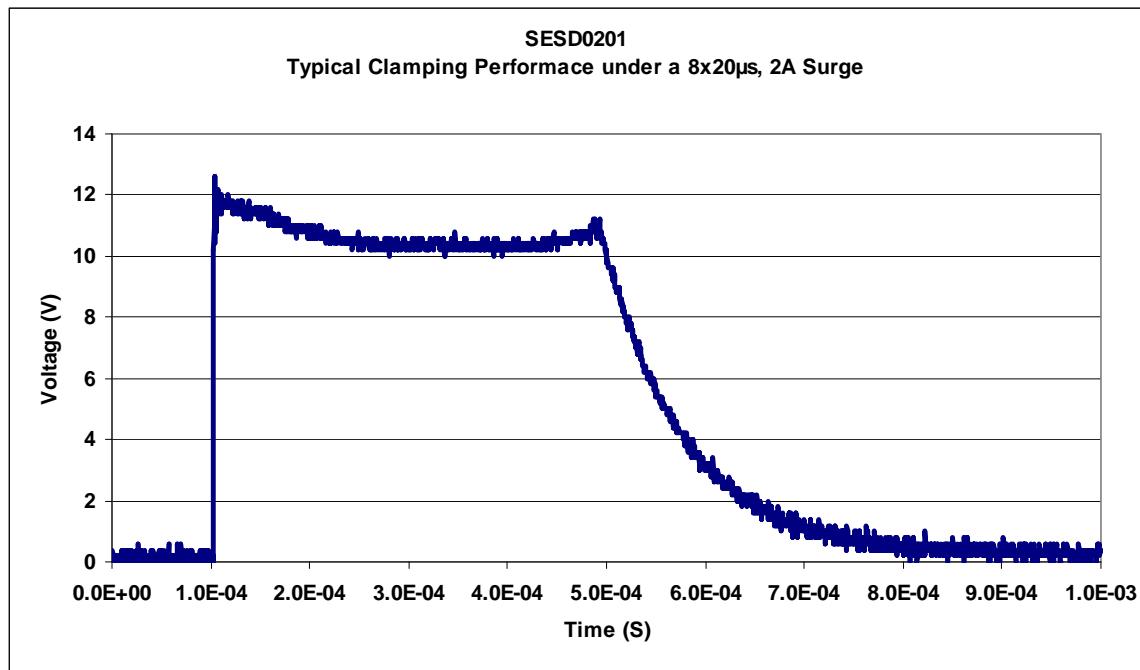
**FIGURE 1: TYPICAL IV CURVE**



**FIGURE 2: ESD CLAMPING VOLTAGE – 8kV Contact**



**FIGURE 3: ESD CLAMPING VOLTAGE – 8x20μs, 2A Surge**



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